

*Enabling superior system cost  
and reliability in Consumer and  
Industrial markets*



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03/2023

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# *Enabling superior system cost and reliability in Consumer and Industrial markets*



- Navitas Semiconductor
- Performance implications of GaN power ICs
- Reliability implications of GaN power ICs
- Application example: High density mobile phone charger
- Application example: High performance motor drive
- Application example: High power SMPS
- Conclusion

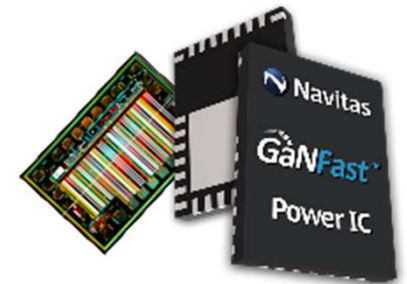


## *Pure-Play Next-Gen Power Semiconductors*

August 15th, 2022: Navitas Semiconductor, industry-leader in gallium nitride power ICs, acquired GeneSiC Semiconductor, silicon carbide pioneer and industry leader

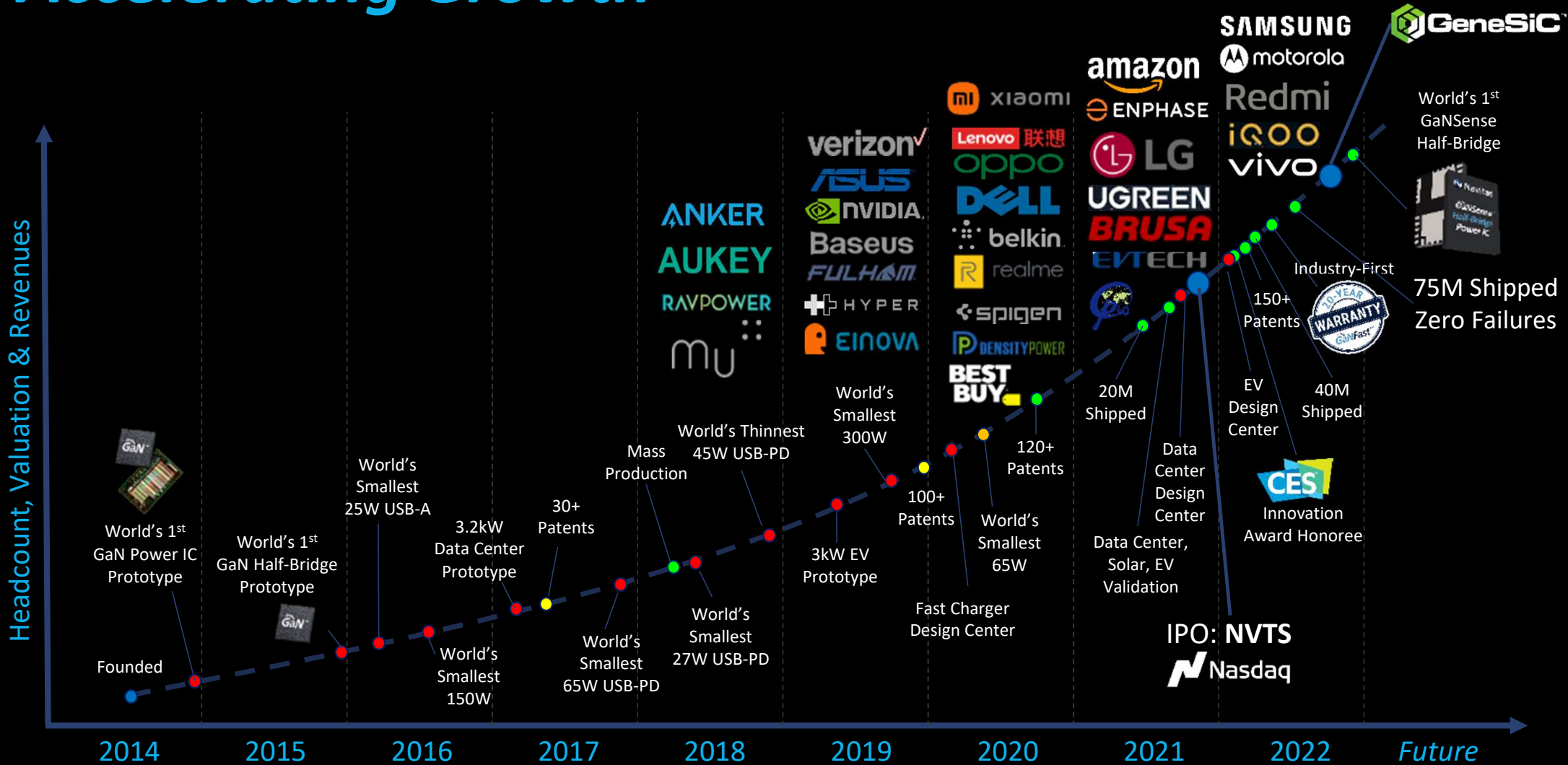
# Navitas Fundamentals<sup>(1)</sup>

- Industry's only pure-play next-gen power semi company, \$23B/yr market
  - Founded 2014, 220+ employees
  - Nasdaq: NVTX (IPO October 2021)
- Leading power GaN IC and power SiC technology, 185+ patents
  - >75M GaN, >9M SiC Shipped
  - 3x (GaN), 5x (SiC) capacity expansion starting in 2023
  - Major diversification in markets, regions
- Mission to Electrify Our World™
  - Industry leader in mobile fast, ultra-fast chargers
  - Market expansion on track / accelerated into data center, solar, EV

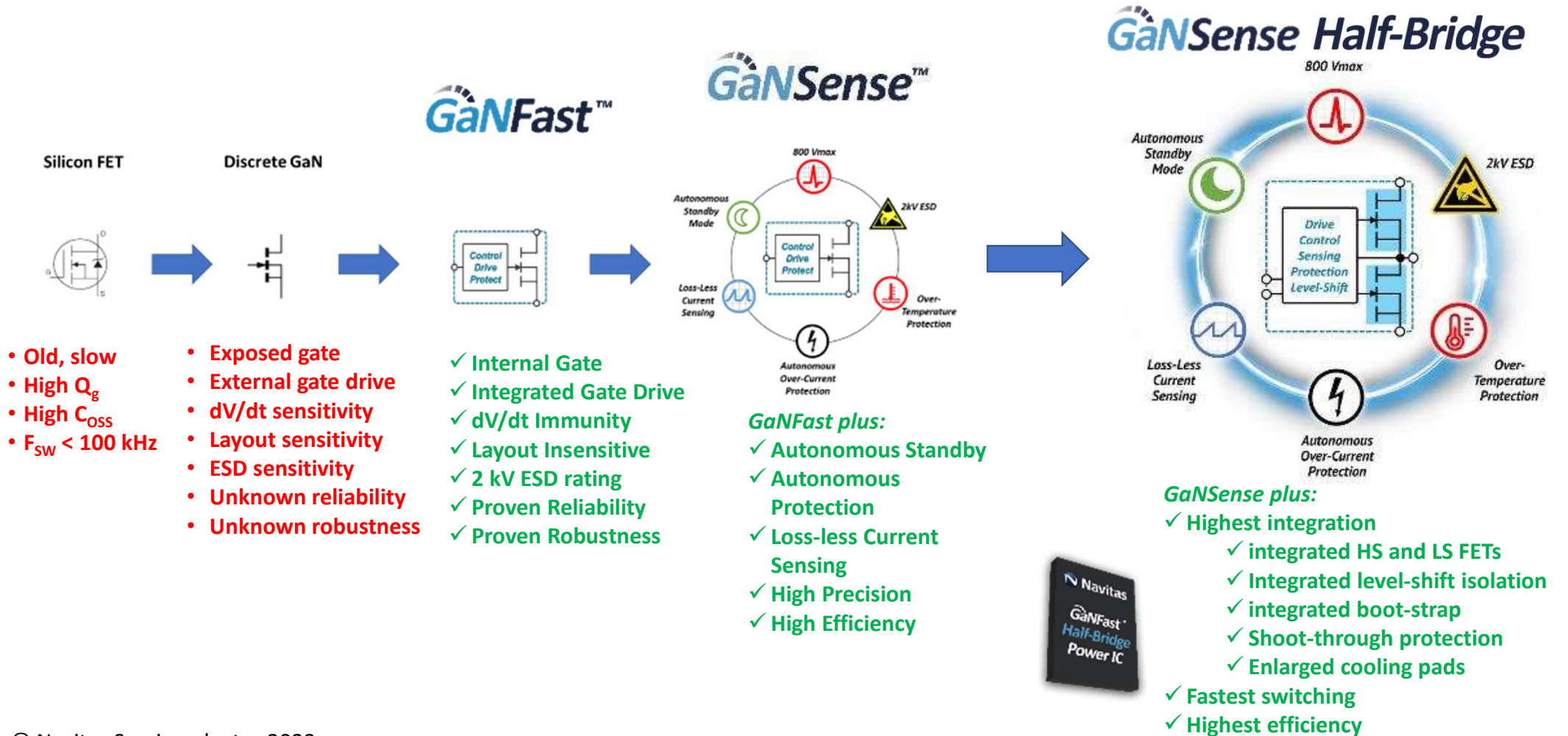


(1) See Navitas New York Investor Meeting September 13<sup>th</sup>, 2022, and Navitas' Q3'22 earnings November 9<sup>th</sup>, 2022, for details

# Accelerating Growth



# Benefits of Integration – what is a GaN power IC?



# Leader in Sustainability



Every **GaNFast™ IC**  
saves<sup>(3)</sup>  
**4 kg CO<sub>2</sub>**



**4x-10x** lower component CO<sub>2</sub> footprint  
than silicon<sup>(1)</sup>

**28% lower** lifetime CO<sub>2</sub> footprint  
for chargers / adapters<sup>(2)</sup>

**Accelerates** transition from ICE to EV by **3 years**,  
saving **20%/yr** of road-sector emissions by 2050<sup>(4)</sup>

GaN saves up to **2.6 Gton / year** by 2050<sup>(5)</sup>

February '22 First GaN sustainability report  
based on global standards.



May '22 World's first semiconductor company  
CarbonNeutral® certified



August '22 First 100,000 tons CO<sub>2</sub> saved

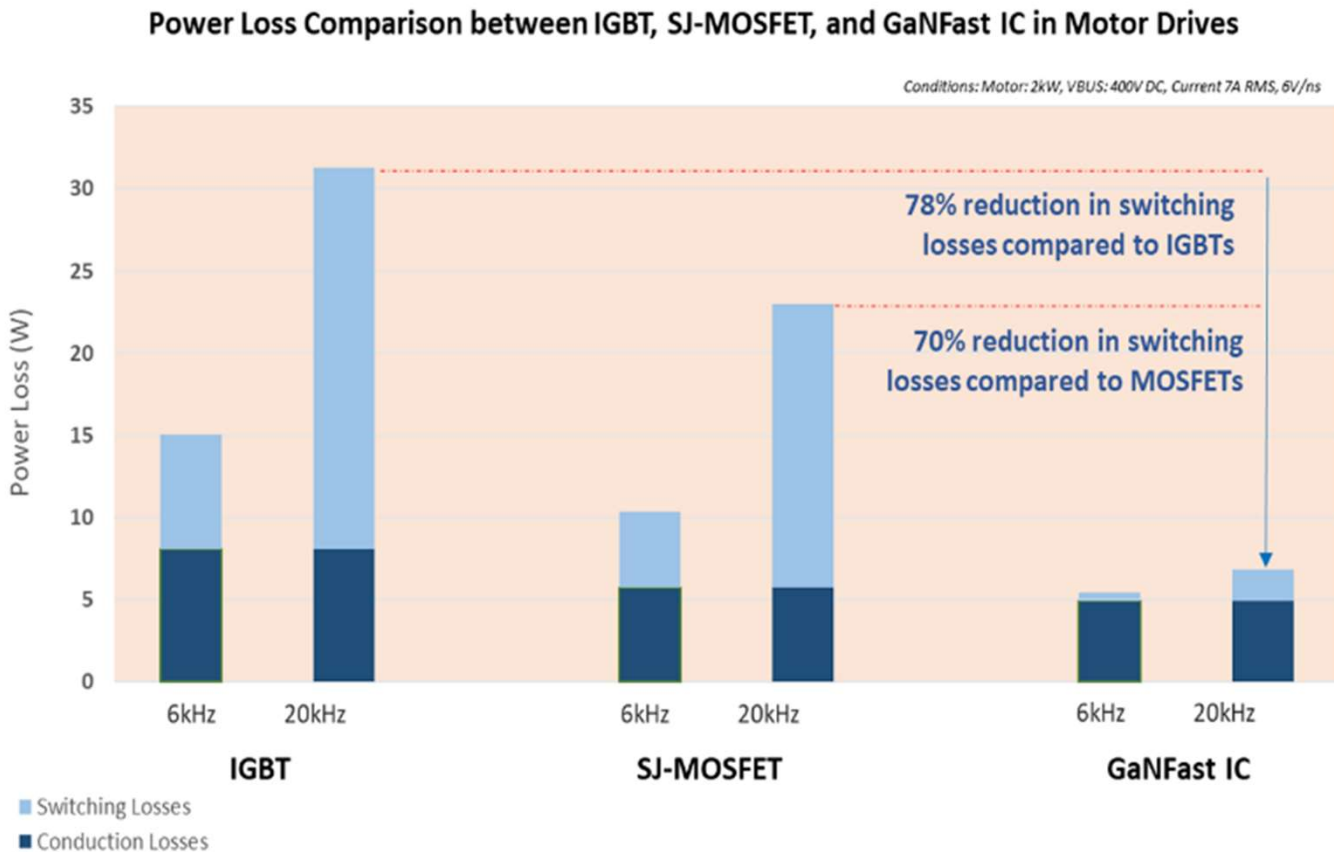


October '22 Recognized for industry-leading  
sustainability reporting

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# Total loss comparison of Silicon IGBT, silicon MOSFET and GaN power IC in a motor drive application



Application case:

- Bus voltage 400V
- Current 7A RMS
- Motor power 2kW
- Switching 6V/ns
- GaN and MOSFET same conduction losses

Using GaN FETs, the inverter efficiency increases by 2.5% (96%→98,5%) and total losses are halved (15W→6,8W)

→ Significant reduction in cost, weight and size of thermal mgmt (like heatsink, fans, other thermal components)

→ Benefit even larger at higher switching frequency

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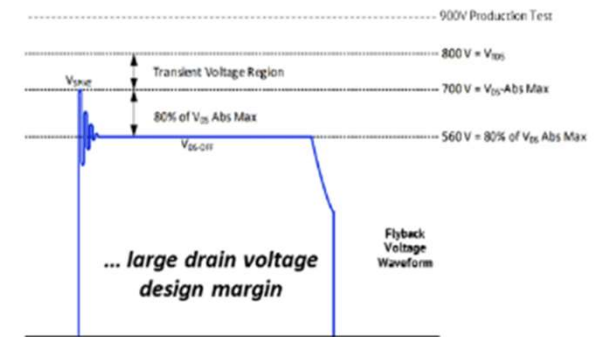
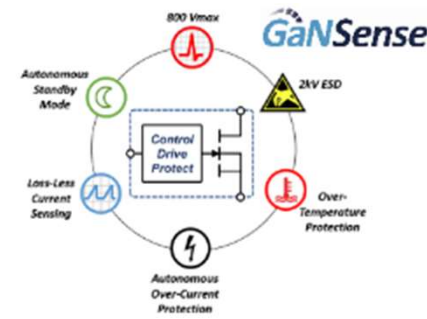
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# Foundational Reliability – driver integration is key



## • **Design** for Reliability

- Integrated drive, sensing and protection
- Component reliability, and **system** reliability



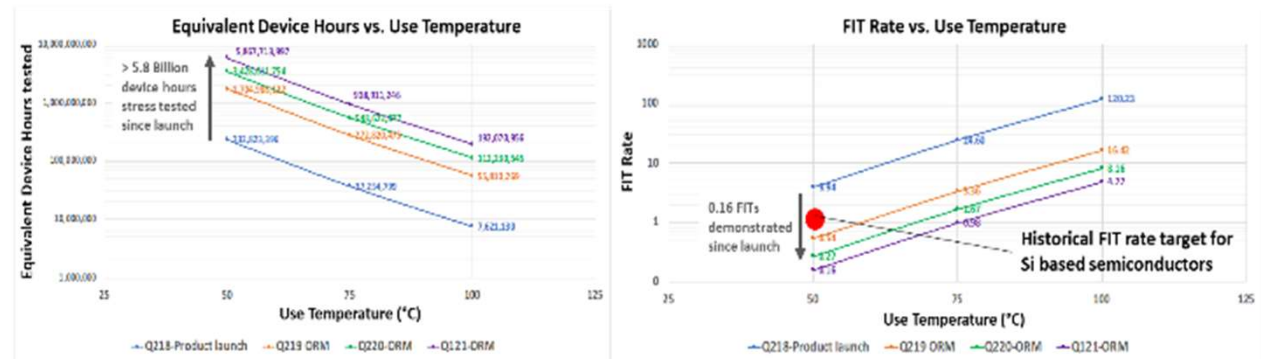
## • **Testing** for Reliability:

- Proprietary production test methods
- GaN ICs tested 400% (multi-temp, high-frequency)

## • **Characterization** for Reliability

- Exhaustive, proactive, and unique Navitas reliability program
- 5.8 B equivalent device hours tested<sup>(1)</sup>
- Proprietary, highly-accelerated Op-Life, plus JEDEC, plus ELFR monitoring
- Founder member of JEDEC JC70.1

Reliability Statistics  
Calculated for High Line condition using HTOL (ZVS) results



(1) As of September 2022

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# 100% Tier 1 Mobile OEMs Adopting Navitas



## Tier 1 OEMs



## Aftermarket Examples



**225+**

GaN Chargers  
Mass Production<sup>(1)</sup>

**290+**

GaN Chargers  
In Development<sup>(1)</sup>

**100%**

Mobile OEMs Designing With  
Navitas GaN ICs

**75M+**

GaN ICs Shipped<sup>(2)</sup>

**Zero**

GaN Field Failures<sup>(2)</sup>

As of March 2023. Based on Navitas shipment data and no customer-reported consumer failures for production shipments.  
© Navitas Semiconductor 2022

# Now Ultra-Fast Chargers

- New, fast-growth market: \$1B opportunity by 2025<sup>(1)</sup>
- Full charge in <10 mins (200W)
- Increased GaN content per charger
- World's highest power density 120W, 150W, 200W

## Key value drivers:

- Lowest losses → High power density
- No big penalty for high switching frequency → Smaller components



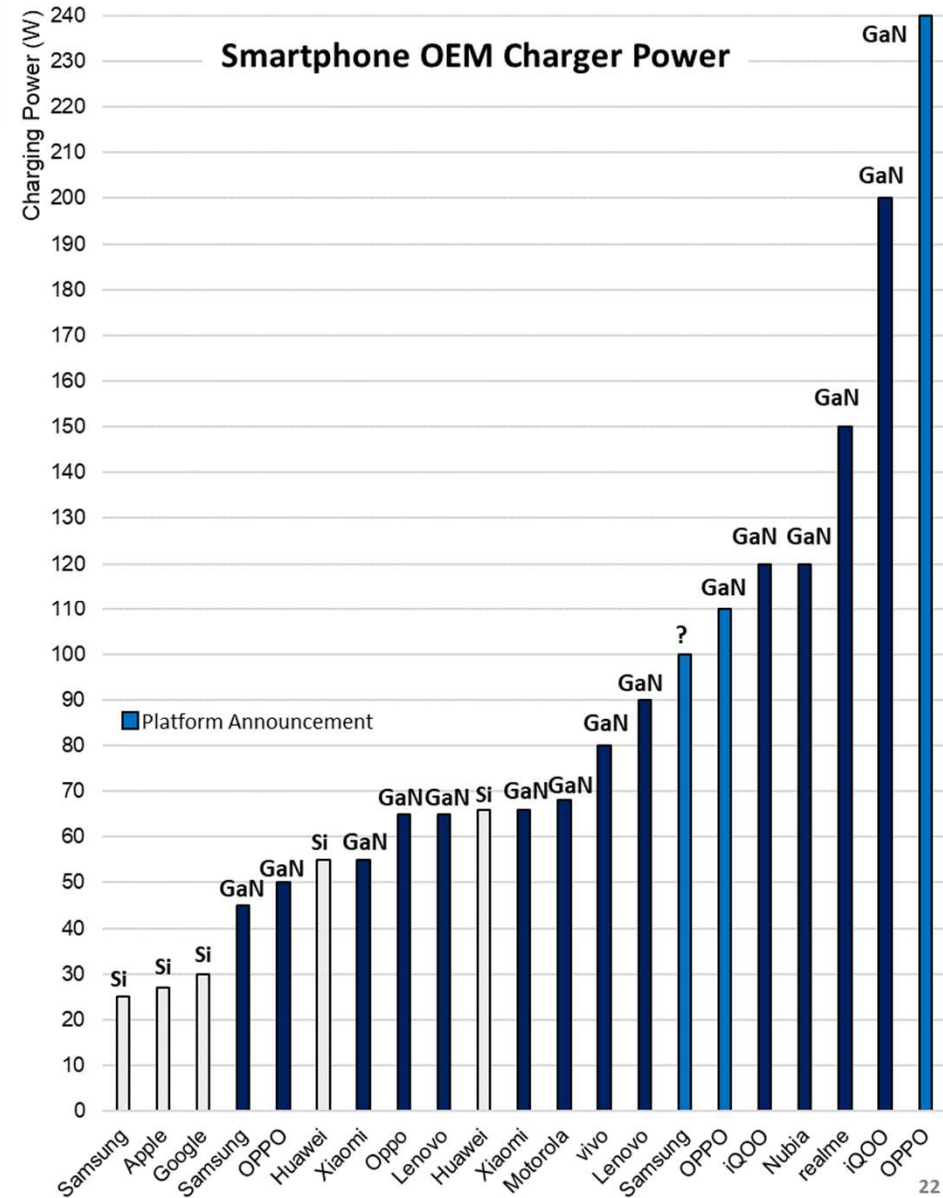
RedMi (Xiaomi) F1 Mercedes 120W



Realme (OPPO) GT Neo 3 150W



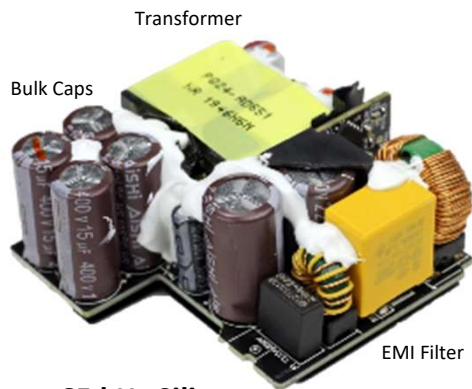
iQOO (vivo) 10 Pro, 200W



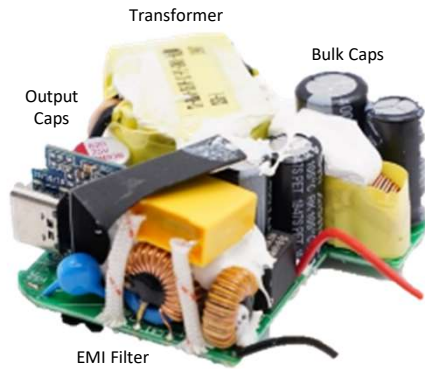
# High Speed Shrinks Passive Components



Typically, slow-speed designs have ~70% of volume used by transformer, capacitors, EMI filter, etc.

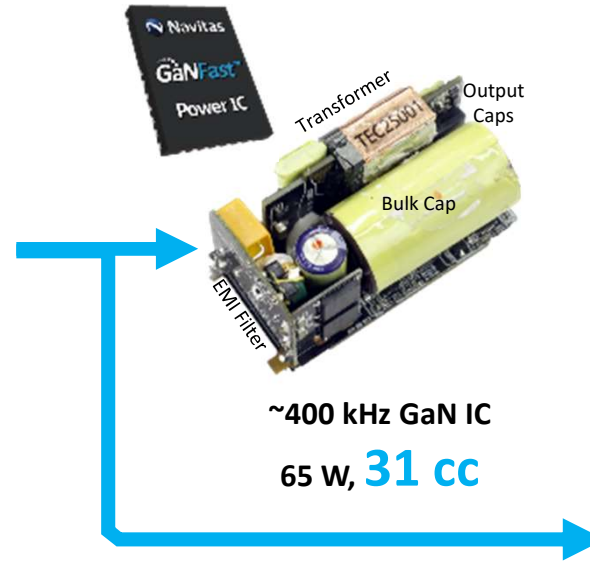


~65 kHz Silicon  
65 W 43 cc



~75 kHz GaN Discrete / MCM  
65 W, 46 cc

High-speed GaN IC designs **shrink** 'passive' components by ~50%<sup>(1)</sup>



~400 kHz GaN IC  
65 W, **31 cc**

Half-Bridge IC delivers ~2x the power, or ~2x faster charging in the **same size**<sup>(1)</sup>



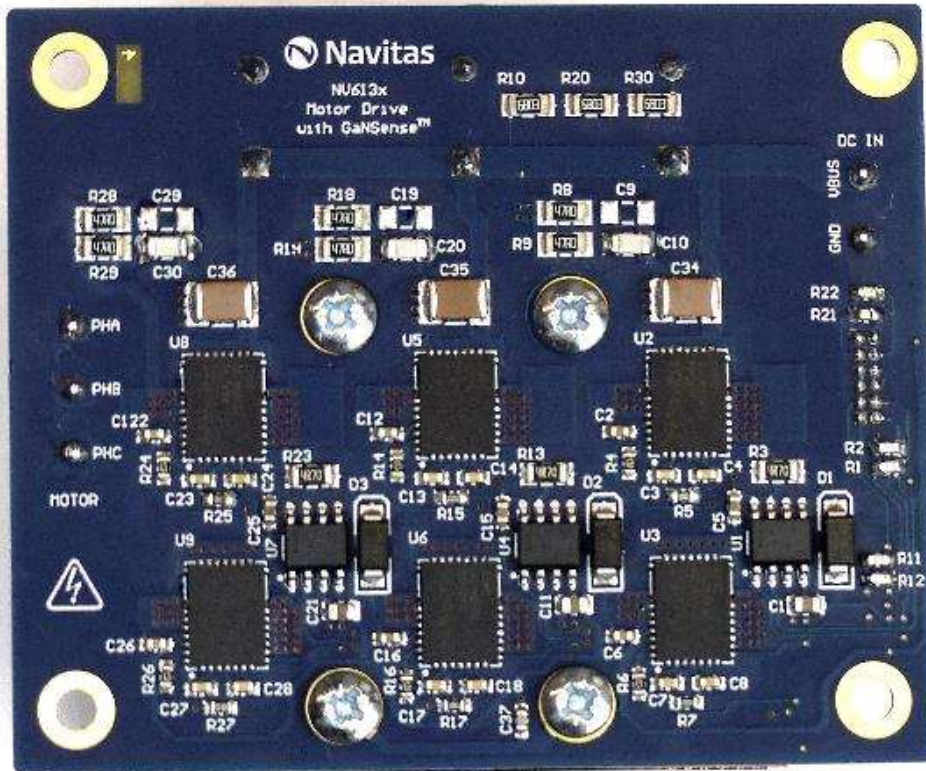
~750 kHz peak Half-Bridge GaN IC  
**120 W, 44 cc**

**~2x faster charging!**

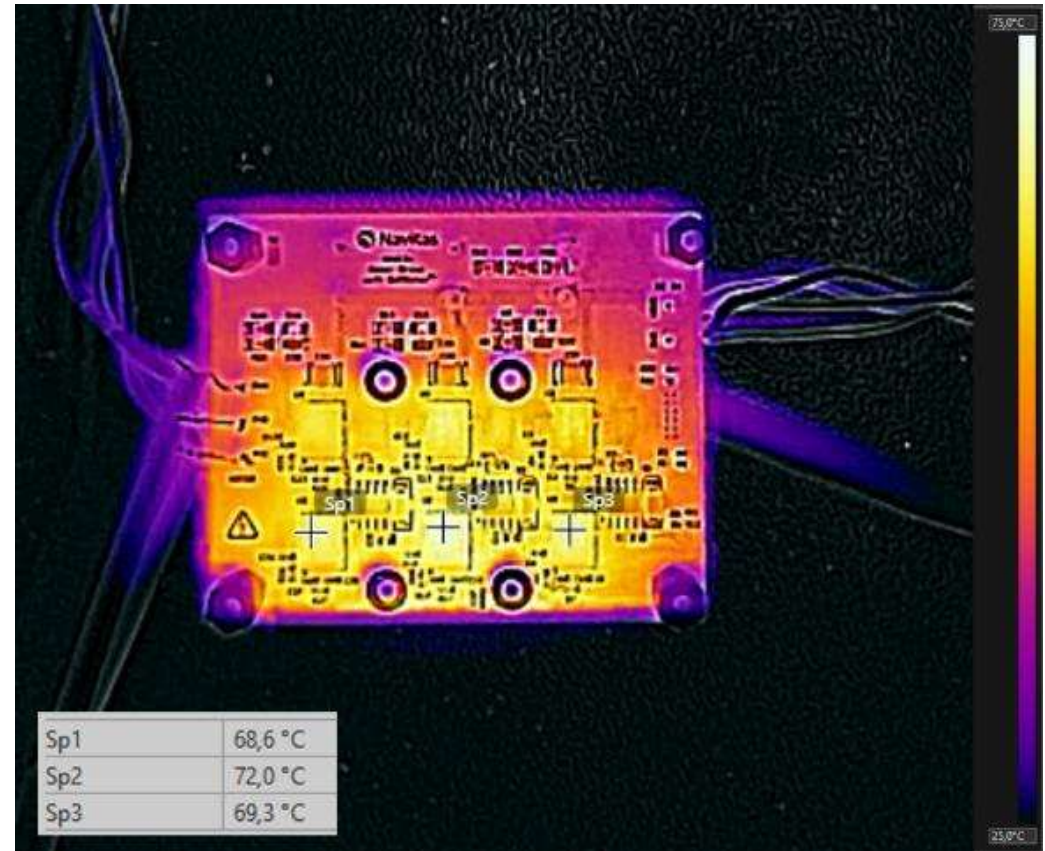
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# Reference design high power 6-in-1 inverter Efficiency >99% at 500W, using NV6138



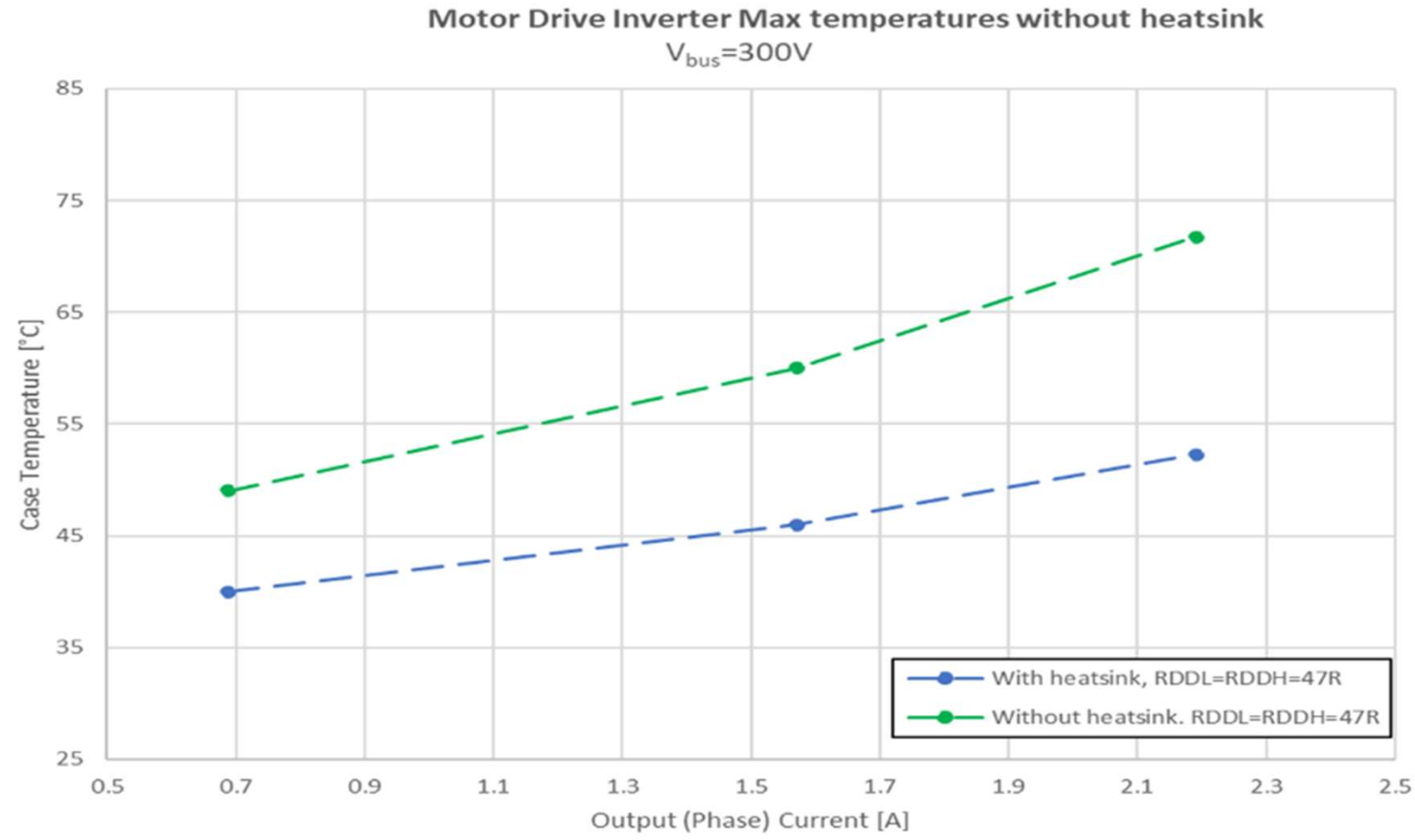
Board size 74mm x 62mm



Thermal scan @ 500W, 20kHz ( $R_{THCA} \sim 20K/W$ ),  $T_{amb} = 25^{\circ}C$   
**No heatsink used**

# Reference design 1kW motor inverter

## Max temperatures with / without heatsink





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# GaNFast Exceeds “Titanium” with >2x Power Density

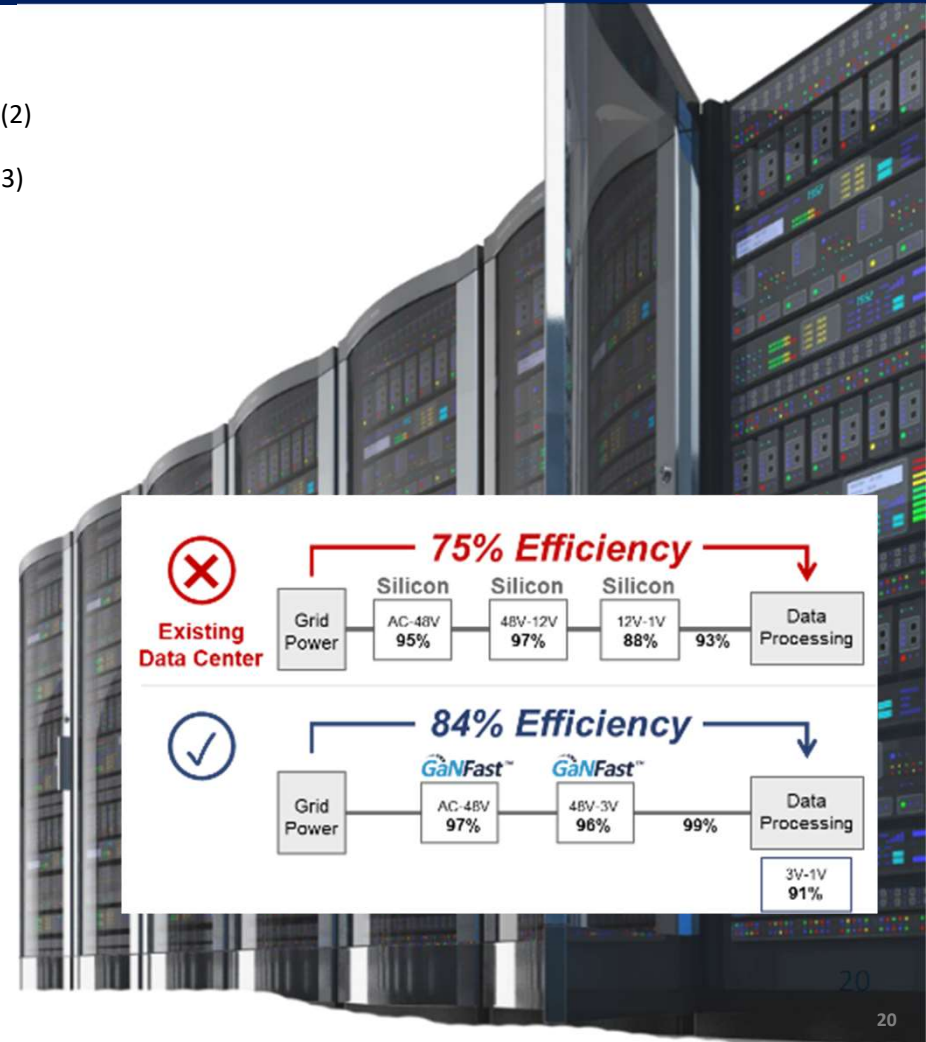


- Euro ‘Titanium plus’ standard from January 1<sup>st</sup>, 2023<sup>(1)</sup>
- System Design Center: 4 platforms: 1.3 kW, 1.6 kW, 2.7 kW, 3.2 kW CRPS<sup>(2)</sup>
- GaN can reduce electricity use by up to 10%, save >15 TWh or \$1.9B/yr <sup>(3)</sup>

Slow Silicon AC-DC 3,200W	GaNFast AC-DC 2,700W
 <p>47 kHz 325 x 107 x 41 mm 2.2 W/cc</p>	 <p>300-500 kHz 185 x 73.5 x 39 mm 5.1 W/cc</p> <ul style="list-style-type: none"> <li>• &gt;2x higher power density</li> <li>• &gt;30% reduction in energy loss</li> </ul>

*“GaN is a breakthrough new technology that is enabling dramatic reductions in size, energy savings and power density”*  
*“Navitas is an excellent partner with industry-leading GaN ICs”*

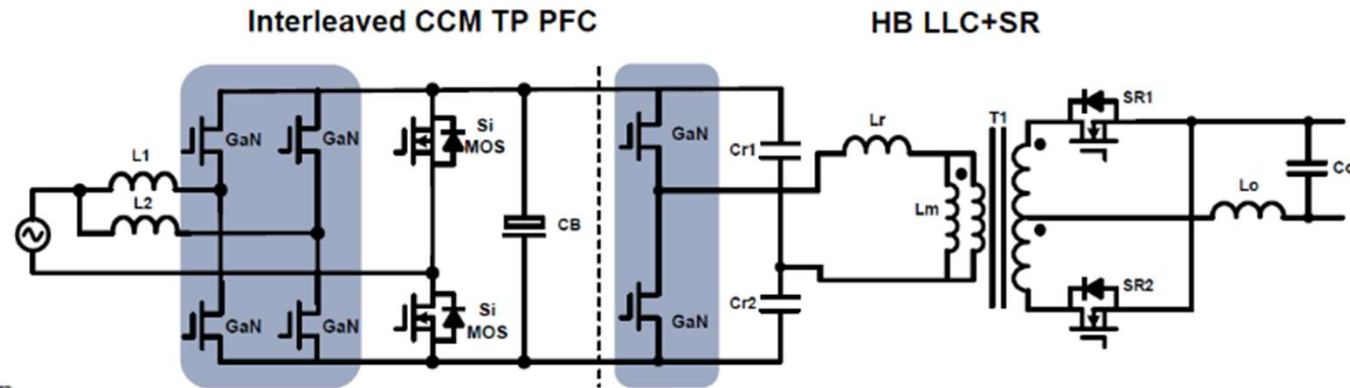
Robin Cheng, VP R&D  肯微科技股份有限公司  
 Compuware Technology Inc.



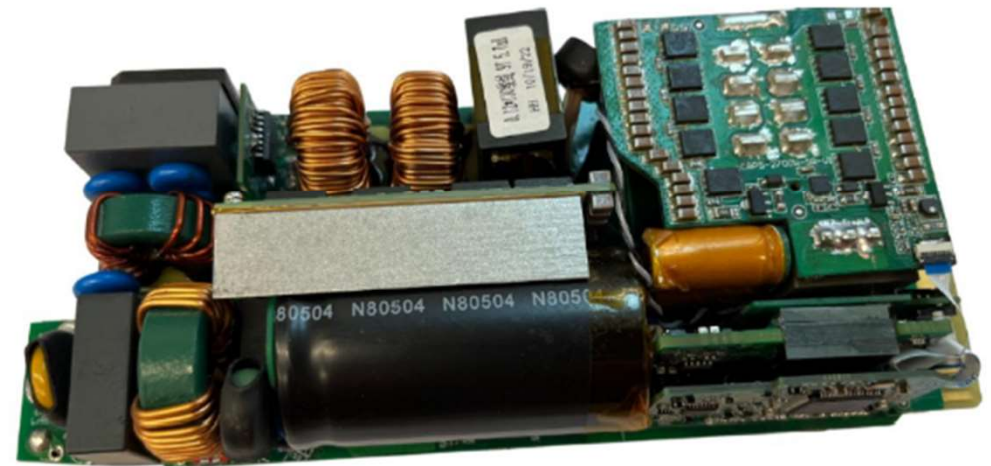
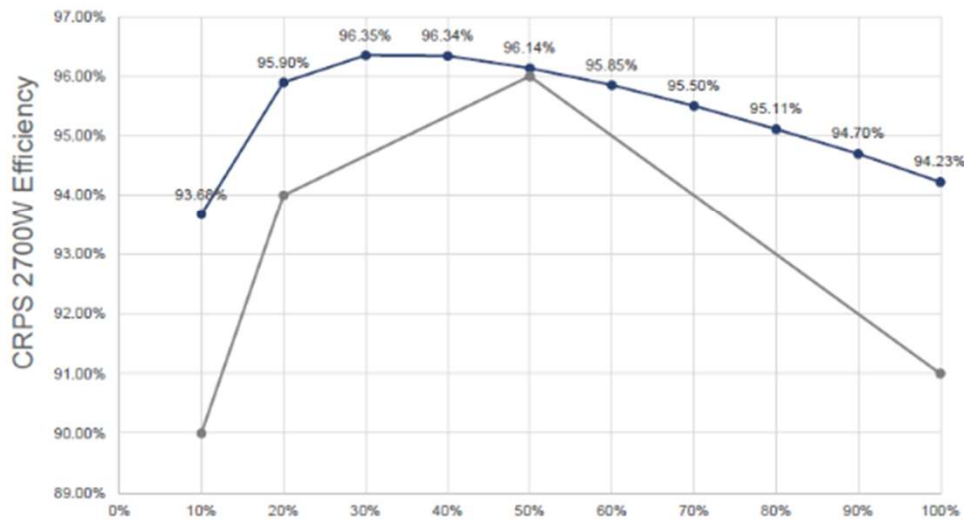
(1) European Union ‘Directive 2009/125/EC, 2019 Annex’, power supplies must be >96% efficiency peak.  
 (2) CRPS = Common Redundant Power Supply standard, defined by Intel for standardized mechanical form-factors, targets hyper-converged compute, storage and networking eqpt.  
 (3) Navitas est. based on a) Navitas server/datacom forecast & AAAS data, b) \$0.12/kWhr, c) Si vs. GaN \$/W and d) data-center loading profile. Estimated based on known existing Si-based solutions to deliver >500A next-generation data processors to Navitas targets for new GaN-based AC/DC and DC/DC for these same next-generation data processors

# GaNFast™ Server power supply 2.7kW Titanium+

- Output power 2.7kW
- Peak efficiency 96.34%
- Power density 5.1W/cc



Vin=230VAC@25C exclude fan

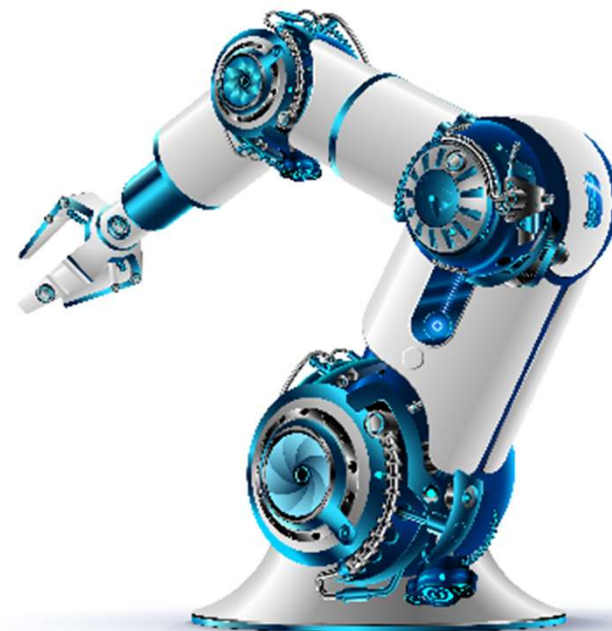


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# Conclusion – The time is now

- Through GaNFast™ / GaNSense™ integration, GaN power ICs are ready now
  - Reliable and repeatable performance of e-mode GaN power transistors
  - Smallest form factor and lowest losses
  - Easy to use digital power stage
- Massive performance improvement over silicon alternatives
- Very good availability and plentiful supply chain – re-using older silicon fabs with little additional expense and waste



GaN power ICs enable the next level of performance, reliability and robustness in power electronics applications

*Thank you!*



**Navitas**

*Energy • Efficiency • Sustainability*

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